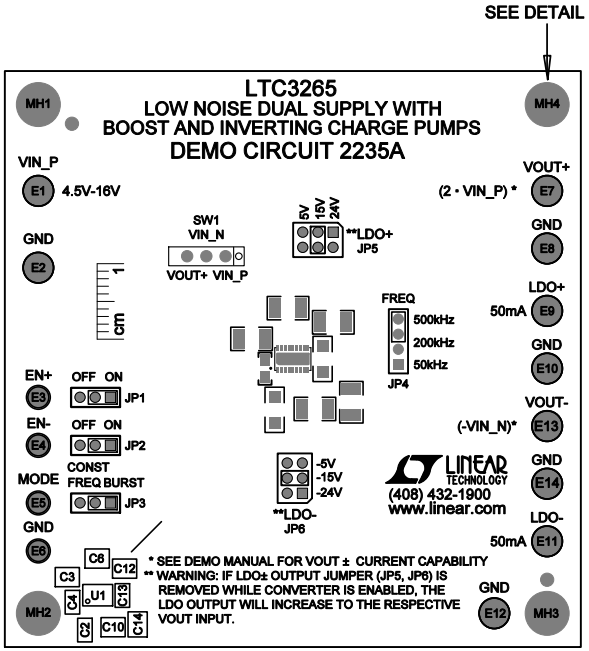
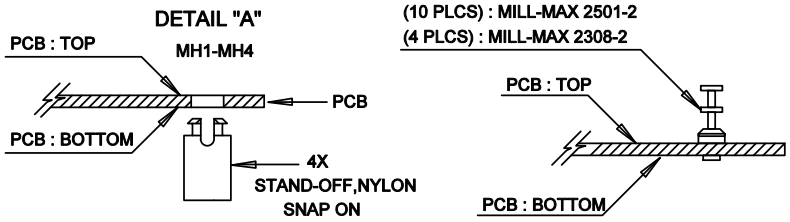
REVISION HISTORY				
ECO	REV	DESCRIPTION	APPR	DATE
-	3	PRODUCTION FAB	MARTY M.	05-28-15



NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
   MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELCIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS
   LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.
   MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT
   TABS ON FOUR SIDES OF THE BOARD EDGE.
6. APPLY ASSEMBLY STAMP OR QA STAMP TO BOTTOM OF BOARD (UNSHOWY AREA).
7. INSTALL TURRETS AND 4 STAND-OFFS AT FOUR CORNERS AS SHOWN BELOW:



APPROVALS	
PCB DES.	NC
APP ENG.	MARTY M.

LINEAR TECHNOLOGY

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TITLE: TOP ASSEMBLY DRAWING:
LOW NOISE DUAL SUPPLY BOOST AND INVERTING CHARGE PUMPS

SIZE	IC NO.	REV.
N/A	LTC3265EDHC DEMO CIRCUIT 2235A	3

SCALE = NONE	FILENAME: DC2235A-3.PCB	SHT 1 of 2